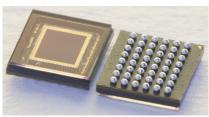


Automotive grade 1.5 megapixel backside illuminated global shutter image



VB56G4ACGK OBGA 6.2 mm x 6.9 mm

Description

Order code

Features

Automotive compliancy

AEC-Q100 grade 2 ongoing



Operating junction temperature: -40°C to 125°C

Ultra compact 1.5 megapixel image sensor

- Global shutter architecture, 3D stacked sensor 40 nm/65 nm
- 2.61 µm x 2.61 µm BSI (backside illuminated) pixel
- 1.5 megapixel monochrome sensor (1124 x 1364)
- Package: OBGA
 - Size: 6.2 mm x 6.9 mm
 - Matrix: 6 x 8 balls Ball pitch: 0.8 mm

Easy integration

- Embedded auto-exposure
- Programmable sequences of 4-frame contexts
- 8 programmable GPIOs
 - NIR (near infrared) illumination control outputs, synchronized with sensor integration periods
 - PWM (pulse-width modulation) control
 - Master/Slave external frame start
- Automatic dark calibration
- Dynamic pixel-defective correction
- Image cropping
- Mirror/flip readout
- Binning and subsampling (x2 and x4)
- Typical power consumption 145 mW at 60 fps
- Dual lane transmitter MIPI CSI-2 up to 1.5 Gbps per lane

Unique image performance

- Peak quantum efficiency 24% @ 940 nm
- Linear dynamic range up to 60 dB
- Up to 88 frames per second at full resolution

Description

The VB56G4A is a 1.5 megapixel global shutter image sensor designed for automotive driver monitoring applications.

Using pre-eminent 3D stacking and ST patented processes, the sensor performs outstandingly in the near infrared region (940 nm). More precisely, thanks to backside illumination technology and its excellent sensitivity, the VB56G4A can be operated with one simple LED or VCSEL.



1 Overview

The VB56G4A is a 1.5 megapixel image sensor that produces raw digital video data on a MIPI CSI-2 output interface.

The image data are digitized using internal 10-bit ADCs. The resulting pixel pattern is output as either RAW10 or RAW8 data.

The device is fully configurable through the I²C serial interface, and provides flexible frame-to-frame configuration changes via the use of programmable contexts.

The VB56G4A has a wide, nonvolatile memory (NVM) and embedded temperature sensor. The device also has general-purpose input/output (GPIO) signals. They can be used to enable synchronization of several sensor readouts or to control strobe light sources during exposure time.

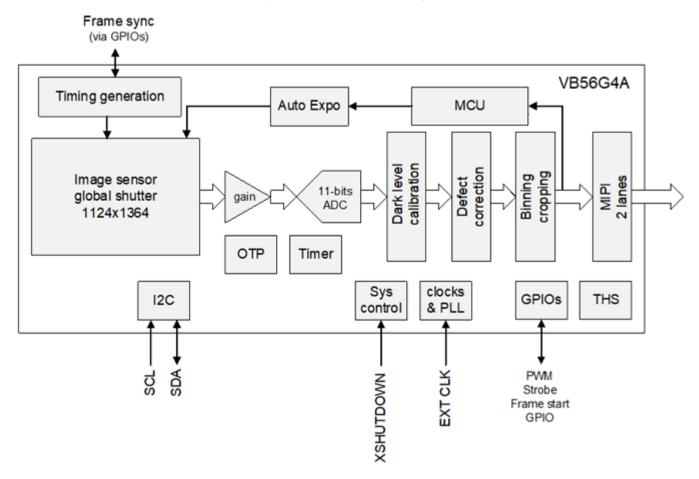


Figure 1. Functional block diagram

DB4717 - Rev 1 page 2/4



Revision history

Table 1. Document revision history

Date	Version	Changes
15-Apr-2022	1	Initial release

DB4717 - Rev 1 page 3/4



IMPORTANT NOTICE - READ CAREFULLY

STMicroelectronics NV and its subsidiaries ("ST") reserve the right to make changes, corrections, enhancements, modifications, and improvements to ST products and/or to this document at any time without notice. Purchasers should obtain the latest relevant information on ST products before placing orders. ST products are sold pursuant to ST's terms and conditions of sale in place at the time of order acknowledgment.

Purchasers are solely responsible for the choice, selection, and use of ST products and ST assumes no liability for application assistance or the design of purchasers' products.

No license, express or implied, to any intellectual property right is granted by ST herein.

Resale of ST products with provisions different from the information set forth herein shall void any warranty granted by ST for such product.

ST and the ST logo are trademarks of ST. For additional information about ST trademarks, refer to www.st.com/trademarks. All other product or service names are the property of their respective owners.

Information in this document supersedes and replaces information previously supplied in any prior versions of this document.

© 2022 STMicroelectronics - All rights reserved

DB4717 - Rev 1 page 4/4